

WP4090KPA

Enhancement Mode N-Channel Power MOSFET

PDFN5x6/NMOS/40V/±20V/1.8V/90A/4.2mΩ

Rev0.2





40V, 4.2mΩ, 90A, Single N-Channel

1.Features

- ◆ 40V MOSFET technology
- Low on-state resistance
- Fast switching
- ♦ Vgs±20V

2.Applications

- Power Switching Application
- Load Switching



Pin Description

3.Package Marking and Ordering Information

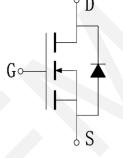
Part no.	Marking	Package	PCS/Reel	PCS/CTN.	
WP4090KPA	WP4090KPA	PDFN5X6	5,000	50,000	

4.Absolute Max Ratings at Ta=25°C (Note1)

Parameter	Symbol	Maximum	Units
Drain to Source Voltage	Vdss	40	V
Gate to Source Voltage	V _{GSS}	±20	V
Drain Current (DC)	lo	90	А
Drain Current (Pulse), PW≤300µs	I _{DP}	360	А
Total Dissipation	PD	50	W
Avalanche Energy, Single Pulsed	Eas	110	mJ
Junction Temperature	Tj	150	°C
Storage Temperature	T _{stg}	-55 to +150	°C

Note 1: Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

V _{DS}	R _{DS(on)} Typ.	I _D Max.	
40V	4.2mΩ @ 10V	004	
	5.6mΩ @ 4.5V	90A	



Schematic Diagram



5.Thermal Resistance Ratings

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction to Case	Rejc	2.5	°C/W

Note 2: When mounted on 1 inch square copper board t \leq 10sec The value in any given application depends on the user's specific board design.

6.Electrical Characteristics at Ta=25°C (Note 3)

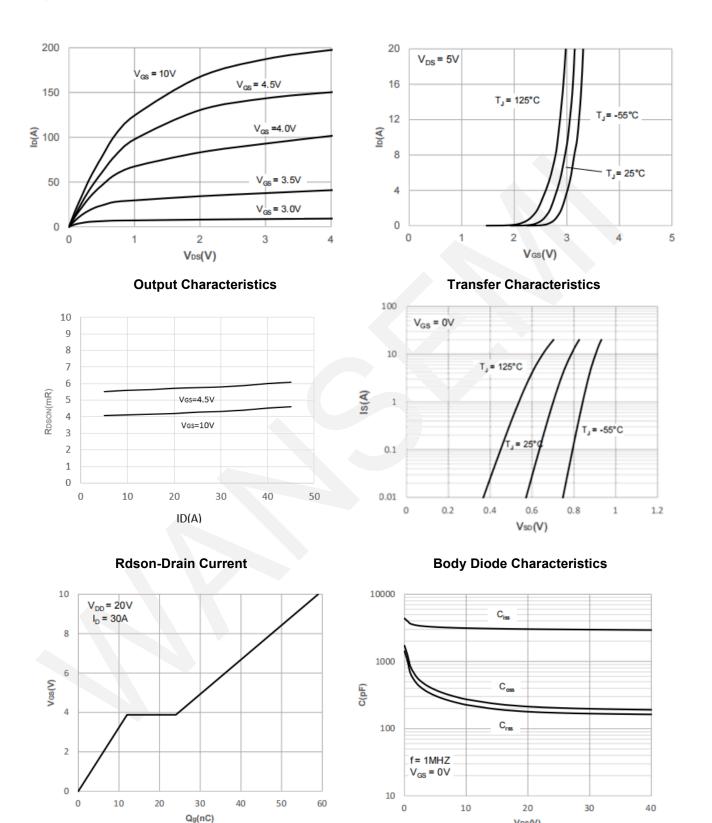
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Drain to Source Breakdown Voltage	V _{(BR)DSS}	I _D = 250µA, V _{GS} = 0V	40	-	-	V
Zero-Gate Voltage Drain Current	IDSS	V_{DS} = 40V, V_{GS} = 0V	-	T	1	uA
Gate to Source Leakage Current	Igss	V_{GS} = ±20V, V_{DS} = 0V	-	1	±100	nA
Gate Threshold Voltage	$V_{GS(th)}$	V _{DS} =V _{GS} , I _{DS} =250µA	1		2.5	V
Static Drain to Source On-State	R _{DS(on)}	I _D = 30A, V _{GS} = 10V	1	4.2	5.5	mΩ
Resistance		I_D = 10A, V_{GS} = 4.5V	-	5.6	9	mΩ
Input Capacitance	Ciss	V _{GS} =0V,	-	3031	-	pF
Output Capacitance	Coss	V _{DS} =20V, Frequency=1.0MHz	-	213	-	pF
Reverse Transfer Capacitance	Crss		-	179	-	pF
Turn-ON Delay Time	t _{d(on)}		-	12	-	ns
Rise Time	tr	V_{DD} = 20V, R_L = 1 Ω	-	11	-	ns
Turn-OFF Delay Time	$t_{d(off)}$	V_{GS} = 10V, R_G = 3 Ω	-	39	-	ns
Fall Time	tr		-	12	-	ns
	Qg	V _{DS} = 20V, V _{GS} = 10V, I _D = 30A	-	59	-	nC
Total Gate Charge	Qgs		-	12	-	nC
	Q _{gd}		-	12	-	nC
Diode Forward Voltage	V _{FSD}	I _S = 20A, V _{GS} = 0	0.4	0.8	1.2	V

Note 3: Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

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7. Typical electrical and thermal characteristics



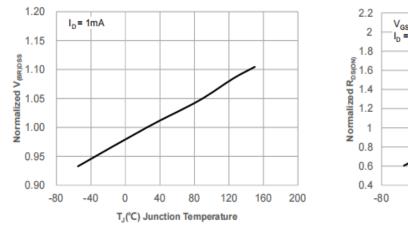
Gate Charge

Capacitance Characteristics

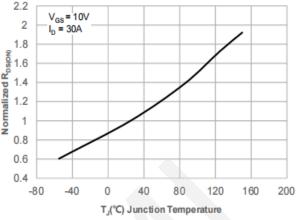
VDS(V)



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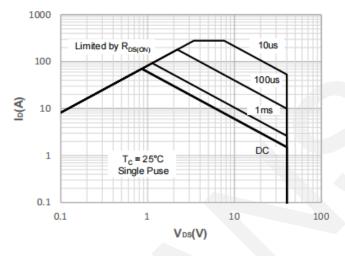


Normalized Breakdown voltage vs. Junction Temperature

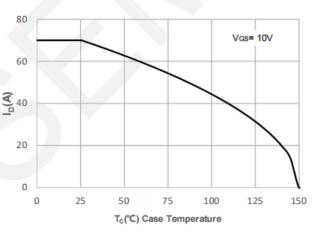


Normalized on Resistance vs.





Maximum Safe Operating Area

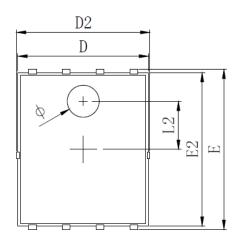


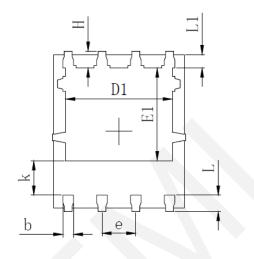
Maximum Continuous Drian Current vs. Case Temperature

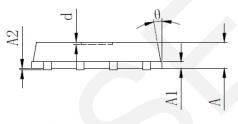




8.Package Dimensions







SYMBOL	MILLIMETER			
STMDUL	MIN	Тур.	MAX	
A	0. 900	1.000	1.100	
A1		0.254 REF.		
A2		0 [~] 0. 05		
D	4.824	4.900	4.976	
D1	3. 910	4.010	4.110	
D2	4.924	5.000	5.076	
E	5.924	6.000	6.076	
E1	3. 375	3. 475	3. 575	
E2	5.674	5. 750	5.826	
b	0.350	0.400	0.450	
е	1.270 TYP.			
L	0.534	0.610	0.686	
L1	0.424	0. 500	0.576	
L2	1.800 REF.			
k	1.190	1.290	1.390	
Н	0. 549	0.625	0.701	
θ	8°	10°	12°	
φ	1.100	1.200	1.300	
d			0.100	



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